



ISL9N302AP3

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N-Channel Logic Level PWM Optimized UltraFET® Trench Power MOSFETs

General Description

This device employs a new advanced trench MOSFET technology and features low gate charge while maintaining low on-resistance.

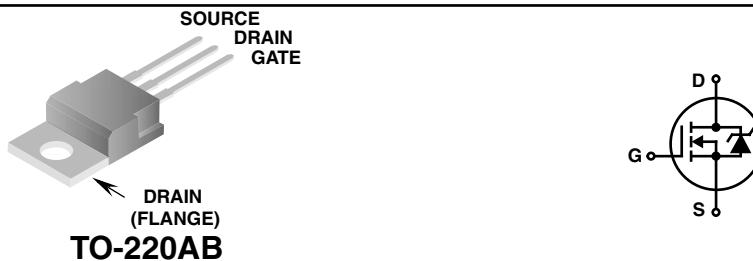
Optimized for switching applications, this device improves the overall efficiency of DC/DC converters and allows operation to higher switching frequencies.

Applications

- DC/DC converters

Features

- Fast switching
- $r_{DS(ON)} = 0.0019\Omega$ (Typ), $V_{GS} = 10V$
- $r_{DS(ON)} = 0.0027\Omega$ (Typ), $V_{GS} = 4.5V$
- Q_g (Typ) = 110nC, $V_{GS} = 5V$
- Q_{gd} (Typ) = 31nC
- C_{iss} (Typ) = 11000pF



MOSFET Maximum Ratings $T_A = 25^\circ C$ unless otherwise noted

Symbol	Parameter	Ratings	Units
V_{DSS}	Drain to Source Voltage	30	V
V_{GS}	Gate to Source Voltage	± 20	V
I_D	Drain Current Continuous ($T_C = 25^\circ C$, $V_{GS} = 10V$)	75	A
	Continuous ($T_C = 100^\circ C$, $V_{GS} = 4.5V$)	75	A
	Pulsed	Figure 4	A
P_D	Power dissipation Derate above $25^\circ C$	345	W
		2.3	$W/\text{ }^\circ C$
T_J , T_{STG}	Operating and Storage Temperature	-55 to 175	$^\circ C$

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance Junction to Case TO-220	0.43	$^\circ C/W$
$R_{\theta JA}$	Thermal Resistance Junction to Ambient TO-220	62	$^\circ C/W$

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
N302AP	ISL9N302AP3	TO-220AB	Tube	N/A	50

Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
Off Characteristics						
B_{VDSS}	Drain to Source Breakdown Voltage	$I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$	30	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 25\text{V}$ $V_{GS} = 0\text{V}$ $T_C = 150^\circ\text{C}$	-	-	1	μA
I_{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20\text{V}$	-	-	± 100	nA

On Characteristics

$V_{GS(\text{TH})}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250\mu\text{A}$	1	-	3	V
$r_{DS(\text{ON})}$	Drain to Source On Resistance	$I_D = 75\text{A}, V_{GS} = 10\text{V}$ $I_D = 75\text{A}, V_{GS} = 4.5\text{V}$	-	0.0019	0.0025	Ω

Dynamic Characteristics

C_{ISS}	Input Capacitance	$V_{DS} = 15\text{V}, V_{GS} = 0\text{V}, f = 1\text{MHz}$	-	11000	-	pF
C_{OSS}	Output Capacitance		-	2000	-	pF
C_{RSS}	Reverse Transfer Capacitance		-	900	-	pF
$Q_{g(\text{TOT})}$	Total Gate Charge at 10V		-	200	300	nC
$Q_{g(5)}$	Total Gate Charge at 5V	$V_{DD} = 15\text{V}$	-	110	165	nC
$Q_{g(\text{TH})}$	Threshold Gate Charge	$I_D = 75\text{A}$	-	12	18	nC
Q_{gs}	Gate to Source Gate Charge	$I_g = 1.0\text{mA}$	-	25	-	nC
Q_{gd}	Gate to Drain "Miller" Charge		-	31	-	nC

Switching Characteristics ($V_{GS} = 4.5\text{V}$)

t_{ON}	Turn-On Time	$V_{DD} = 15\text{V}, I_D = 28\text{A}$ $V_{GS} = 4.5\text{V}, R_{GS} = 1.5\Omega$	-	-	224	ns
$t_{d(\text{ON})}$	Turn-On Delay Time		-	29	-	ns
t_r	Rise Time		-	120	-	ns
$t_{d(\text{OFF})}$	Turn-Off Delay Time		-	45	-	ns
t_f	Fall Time		-	34	-	ns
t_{OFF}	Turn-Off Time		-	-	119	ns

Switching Characteristics ($V_{GS} = 10\text{V}$)

t_{ON}	Turn-On Time	$V_{DD} = 15\text{V}, I_D = 28\text{A}$ $V_{GS} = 10\text{V}, R_{GS} = 1.5\Omega$	-	-	204	ns
$t_{d(\text{ON})}$	Turn-On Delay Time		-	16	-	ns
t_r	Rise Time		-	120	-	ns
$t_{d(\text{OFF})}$	Turn-Off Delay Time		-	70	-	ns
t_f	Fall Time		-	30	-	ns
t_{OFF}	Turn-Off Time		-	-	150	ns

Unclamped Inductive Switching

t_{AV}	Avalanche Time	$I_D = 7.2\text{A}, L = 3.0\text{mH}$	480	-	-	μs
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Drain-Source Diode Characteristics

V_{SD}	Source to Drain Diode Voltage	$I_{SD} = 75\text{A}$	-	-	1.25	V
		$I_{SD} = 40\text{A}$	-	-	1.0	V
t_{rr}	Reverse Recovery Time	$I_{SD} = 75\text{A}, dI_{SD}/dt = 100\text{A}/\mu\text{s}$	-	-	42	ns
Q_{RR}	Reverse Recovered Charge	$I_{SD} = 75\text{A}, dI_{SD}/dt = 100\text{A}/\mu\text{s}$	-	-	34	nC

Typical Characteristic

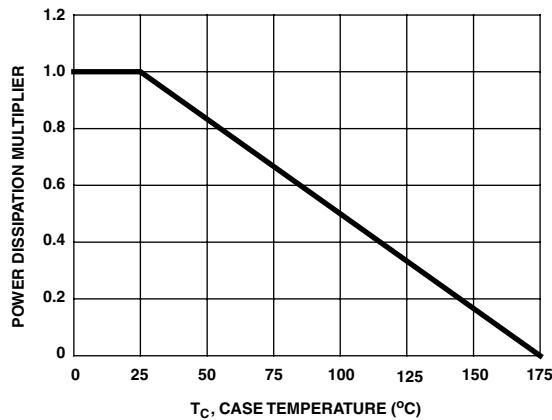


Figure 1. Normalized Power Dissipation vs Ambient Temperature

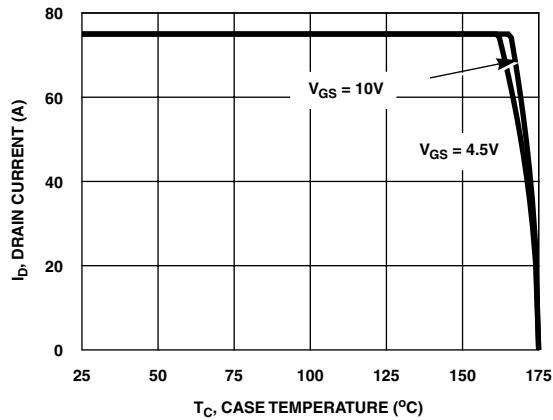


Figure 2. Maximum Continuous Drain Current vs Case Temperature

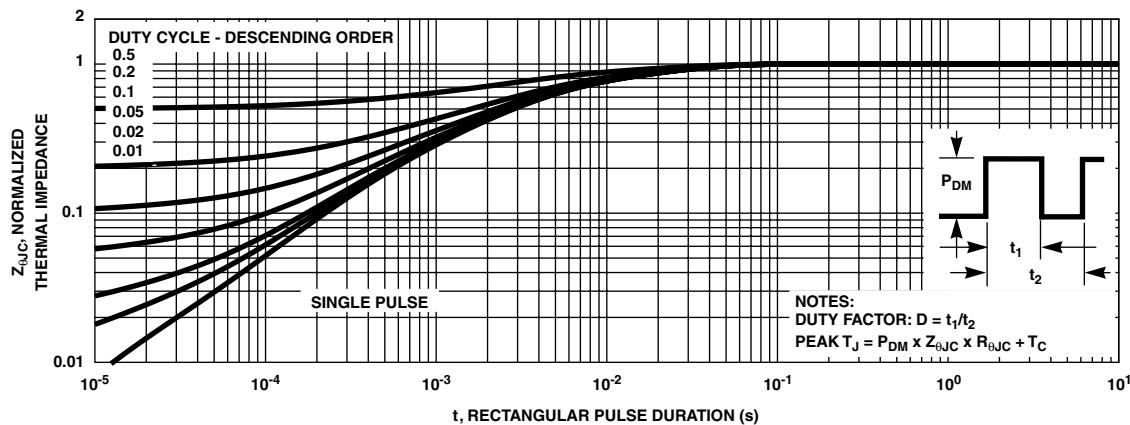


Figure 3. Normalized Maximum Transient Thermal Impedance

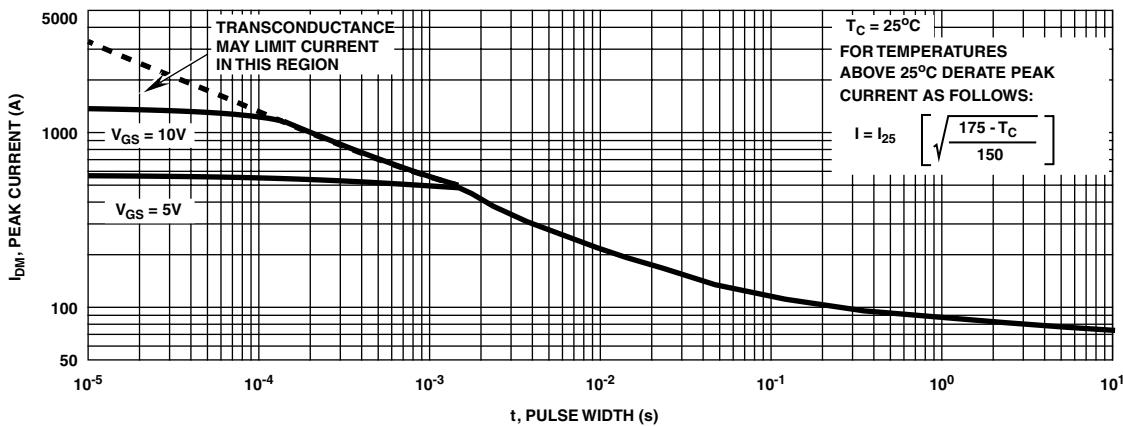


Figure 4. Peak Current Capability